Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2814	(applied adj materials) and (electroplating or (electro adj plating) or plating or (electrochemical adj plating))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/02 10:44
L2	96	I1 and loading near2 (station or dock)and (plating or electroplating) adj (cell or station) and (anneal\$4 or heat\$4)	US-PGPUB; USPAT	OR	ON	2005/09/02 11:02
L3	86	L2 and (SRD or (spin rinse dry) or (bead removal) or (bevel cleaning))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/09/02 10:48
L5	12	l1 and (loading near2 (station or dock)and (plating or electroplating or process\$4) adj (cell or station) and (anneal\$4 or heat\$4)).clm.	US-PGPUB; USPAT	OR	ON	2005/09/02 10:47
L7	9	L5 and (SRD or (spin rinse dry) or ((bead or bevel) adj (removal or clean\$3)) or EBR).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/09/02 11:44
S1 .		10/616284	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2005/09/01 16:36
S2	47	("5224504" "5252196" "5489341" "5573023" "5620581" "5731678" "5744019" "5837120" "5883762" "5996241" "6014817" "6099702" "6099712" "6126798" "6132857" "6136163" "6156167" "6179983" "6197181" "6228231" "6228232" "6241433" "6248222" "6254742" "6267853" "6273110" "6280582" "6290833" "6319387" "6322674" "6322678" "6334937" "6368475" "6374837" "6383352" "6391166" "6395101" "6395152" "6409892" "6432821" "6436249" "6440295" "6527920" "6551479" "6551487" "6569299" "6589401").PN.	US-PGPUB; USPAT	OR	ON	2005/09/01 16:36

		F				
S3	43	("20020033340" "20020063097" " 20030010640" "20030116445" "2 0030159937" "20040016636" "20 040016637" "20040016647" "200 40074761" "20040074762" "2004 0118694" "20040134775" "20040 149573" "20040192066" "200402 00725" "20040206628" "2004021 7005" "4296672" "4469564" "463 2651" "4840820" "5071591" "516 2079" "5287237" "5435903" "548 2680" "5486264" "5516418" "559 7460" "5643456" "5656386" "570 5050" "5714521" "5785833" "608 0291" "6090260" "6270635" "634 7837" "6423642" "6518184" "658 9874" "6592736" "6740221").PN.	US-PGPUB; USPAT	OR	ON	2005/09/01 16:37
S5	2	("20020074233" "6261433").PN.	US-PGPUB; USPAT	OR	ON	2005/09/01 16:58
S6	92	S2 S3 S4	US-PGPUB; USPAT	OR	ON	2005/09/01 16:59
S7	7	S6 and loading and plating adj (cell or station) and (anneal\$4 or heat\$4) and (bevel or bead)	US-PGPUB; USPAT	OR	ON	2005/09/01 17:06
S8	4	S6 and loading near2 station and plating adj (cell or station) and (anneal\$4 or heat\$4) and (bevel or bead)	US-PGPUB; USPAT	OR .	ON	2005/09/01 17:08
S9	9	S6 and loading near2 (station or dock)and (plating or electroplating) adj (cell or station) and (anneal\$4 or heat\$4)	US-PGPUB; USPAT	OR	ON	2005/09/02 10:44

S10	100	(US-6027796-\$ or US-4486232-\$	USPAT	OR	ON	2005/09/01 19:45
	100	or US-6228246-\$ or US-6699380-\$	03171		011	2003/03/01 13.43
		or US-6852209-\$ or US-6875331-\$				
		or US-6878258-\$ or US-6179990-\$	·			
i		·				
		or US-4779957-\$ or US-4781789-\$				
		or US-4781790-\$ or US-4783236-\$				
		or US-4795528-\$ or US-4949157-\$				
		or US-5412239-\$ or US-5463235-\$				
		or US-6332016-\$ or US-5250760-\$				
		or US-5861327-\$ or US-5998739-\$				
		or US-6018197-\$ or US-4082625-\$				
		or US-4316201-\$ or US-4417267-\$				
		or US-4441974-\$ or				
		US-4478690-\$).did. or				
		(US-4494688-\$ or US-4632728-\$				
		or US-4829023-\$ or US-4933208-\$				
		or US-4935305-\$ or US-5187860-\$				
		or US-5272376-\$ or US-5302554-\$				
		or US-5323056-\$ or US-5399510-\$				
		or US-5426850-\$ or US-5428840-\$				
		or US-5616423-\$ or US-5664325-\$, ,	
		or US-5702871-\$ or US-5770474-\$				
		or US-5811883-\$ or US-5932325-\$				
		or US-6054037-\$ or US-6066551-\$			İ	
		or US-6126844-\$ or US-6160350-\$				
		or US-6235544-\$ or US-6265671-\$				
		or US-6307161-\$ or US-6350176-\$				
		,				
		or US-6617688-\$).did. or				
		(US-6698084-\$ or US-6835576-\$				
		or US-5448605-\$ or US-5600691-\$				
		or US-5773096-\$ or US-5805653-\$				
		or US-6398929-\$ or US-6402592-\$				
	•	or US-6413383-\$ or US-6551484-\$,		
		or US-6576110-\$ or US-6582578-\$				
		or US-6613200-\$ or US-6708701-\$				
		or US-6786996-\$ or US-6843897-\$				
		or US-6855235-\$ or US-6863794-\$				
		or US-6869516-\$ or US-6911136-\$				
		or US-5227689-\$ or US-5843538-\$				
		or US-6045866-\$ or US-6159768-\$				
		or US-4378626-\$ or US-4428814-\$				
		or US-4595452-\$).did. or				
		(US-4602239-\$ or US-4766813-\$			1	
		or US-4871582-\$ or US-4975142-\$				
		or US-5001591-\$ or US-5214571-\$				
		or US-5260234-\$ or US-5290971-\$				
		or US-5296407-\$ or US-5298282-\$				
		or US-5306571-\$ or US-5418059-\$		1		
		or US-5427869-\$ or US-5463248-\$				
		or US-5473194-\$ or US-5484324-\$				
		or US-5592025-\$ or US-5620581-\$				
		or US-5626278-\$ or				
		·			-	
Ll		US-5667661-\$).did.		<u> </u>	<u> </u>	

S12	26	S10 and ("204"/\$.ccls. or "205"/\$.ccls.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/01 19:48
S13	5	S12 and stack\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/01 19:47
S14	50	("204"/\$.ccls. or "205"/\$.ccls.) and stack\$4 with anneal\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/01 19:50
S15	22609	("204"/\$.ccls. or "205"/\$.ccls.) and (electroplating or (electro adj plating) or plating or (electrochemical adj plating))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/01 20:11
S16	15	S15 and stack\$4 with anneal\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/01 20:02
S17	47	("5224504" "5252196" "5489341" "5573023" "5620581" "5731678" "5744019" "5837120" "5883762" "5996241" "6014817" "6099702" "6099712" "6126798" "6132857" "6136163" "6156167" "6179983" "6197181" "6228231" "6228232" "6241433" "6248222" "6254742" "6267853" "6273110" "6280582" "6290833" "6319387" "6322674" "6322678" "6334937" "6368475" "6374837" "6383352" "6391166" "6395101" "6395152" "6409892" "6432821" "6436249" "6440295" "6527920" "6551479" "6551487" "6569299" "6589401").PN.	US-PGPUB; USPAT	OR	ON	2005/09/01 20:01

S18	43	("20020022240" "20020062007" "	LIC DCDLID:	OR	ON	2005/00/01 20:01
310	73	("20020033340" "20020063097" " 20030010640" "20030116445" "2 0030159937" "20040016636" "20 040016637" "20040016647" "200 40074761" "20040074762" "2004 0118694" "20040134775" "20040 149573" "20040192066" "200402 00725" "20040206628" "2004021 7005" "4296672" "4469564" "463 2651" "4840820" "5071591" "516 2079" "5287237" "5435903" "548 2680" "5486264" "5516418" "559 7460" "5643456" "55566386" "570 5050" "5714521" "5785833" "608 0291" "6090260" "6270635" "634 7837" "6423642" "6518184" "658 9874" "6592736" "6740221").PN.	US-PGPUB; USPAT	OK .	ON	2005/09/01 20:01
S19	2	("0074233" "6261433").PN.	US-PGPUB; USPAT	OR	ON	2005/09/01 20:01
S20	92	S17 S18 S19	US-PGPUB; USPAT	OR .	ON	2005/09/01 20:01
S21	1	S20 and (stack\$4 with anneal\$4)	US-PGPUB; USPAT	OR	ON	2005/09/01 20:03
S23	2814	(applied adj materials) and (electroplating or (electro adj plating) or plating or (electrochemical adj plating))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/01 20:03
S24	22	S23 and (stack\$4 with anneal\$4)	US-PGPUB; USPAT	OR	ON	2005/09/01 20:03
S25	121	S15 and (SRD or (spin rinse dry) or (bead removal) or (bevel cleaning))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/09/02 10:45
S26	25	S15 and (SRD or (spin rinse dry) or (bead or bevel) adj (clean\$4 or removal)).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/09/01 20:30
S28	25	electroless plating and (SRD or (spin rinse dry) or (bead or bevel) adj (clean\$4 or removal)).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/09/01 20:32

S29	18	S28 not S26	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/09/01 20:38
S33	2	("20040118694" or "20040016636").pn.	US-PGPUB; USPAT	ADJ	ON	2005/09/01 20:43
S34	10	60/435121 or 60/448575 or 60/463956 or 60/463862 or 60/463860 or 60/463970	US-PGPUB; USPAT	ADJ	ON	2005/09/01 20:45
S35	10	S34 and stack\$4	US-PGPUB; USPAT	ADJ	ON	2005/09/01 20:46
S36	2	S34 and stack\$4 with anneal\$4	US-PGPUB; USPAT	ADJ	ON	2005/09/01 20:45
S37	22609	("204"/\$.ccls. or "205"/\$.ccls.) and (electroplating or (electro adj plating) or plating or (electrochemical adj plating))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2005/09/02 09:16
S38	601	S37 and anolyte and catholyte	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/02 09:17
S39	464	S37 and anolyte and catholyte and membrane	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/02 09:17
S40	27	S37 and anolyte and catholyte and membrane and diffuser	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/02 09:17